

# Filterless High Efficiency Mono 1.4 W Class-D Audio Amplifier

# SSM2301

#### **FEATURES**

Filterless Class-D amplifier with  $\Sigma$ - $\Delta$  modulation No sync necessary when using multiple Class-D amplifiers from Analog Devices, Inc. 1.4 W into 8  $\Omega$  at 5.0 V supply with less than 1% THD + N 85% efficiency at 5.0 V, 1.4 W into 8  $\Omega$  speaker Greater than 98 dB SNR (signal-to-noise ratio) Single-supply operation from 2.5 V to 5.0 V 20 nA ultralow shutdown current Short-circuit and thermal protection Available in 8-lead, 3 mm × 3 mm LFCSP and MSOP packages **Pop-and-click suppression** Built-in resistors reduce board component count Fixed and user-adjustable gain configurations

#### **APPLICATIONS**

**Mobile phones MP3 players Portable gaming Portable electronics Educational toys** 

#### **GENERAL DESCRIPTION**

The SSM2301 is a fully integrated, high efficiency, Class-D audio amplifier designed to maximize performance for mobile phone applications. The application circuit requires a minimum of external components and operates from a single 2.5 V to 5.0 V supply. It is capable of delivering 1.4 W of continuous output power with less than 1% THD + N driving an 8  $\Omega$  load from a 5.0 V supply.

The SSM2301 features a high efficiency, low noise modulation scheme that does not require external LC output filters. The modulation provides high efficiency even at low output power.

The SSM2301 operates with 85% efficiency at 1.4 W into 8  $\Omega$ from a 5.0 V supply and has a signal-to-noise ratio (SNR) that is greater than 98 dB. Spread-spectrum modulation is used to provide lower EMI-radiated emissions compared with other Class-D architectures.

The SSM2301 has a micropower shutdown mode with a maximum shutdown current of 30 nA. Shutdown is enabled by applying a logic low to the SD pin.

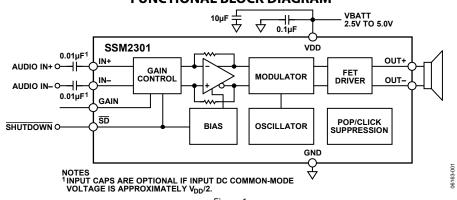
The device also includes pop-and-click suppression circuitry. This minimizes voltage glitches at the output during turn-on and turn-off, thus reducing audible noise on activation and deactivation.

The fully differential input of the SSM2301 provides excellent rejection of common-mode noise on the input. Input coupling capacitors can be omitted if the dc input common-mode voltage is approximately  $V_{DD}/2$ .

The SSM2301 also has excellent rejection of power supply noise, including noise caused by GSM transmission bursts and RF rectification. PSRR is typically 63 dB at 217 Hz.

The gain can be set to 6 dB or 12 dB by utilizing the gain control select pin connected respectively to ground or to VDD. Gain can also be adjusted externally by inserting a resistor in series with each input pin.

The SSM2301 is specified over the commercial temperature range (-40°C to +85°C). It has built-in thermal shutdown and output short-circuit protection. It is available in both an 8-lead, 3 mm × 3 mm lead-frame chip scale package (LFCSP) and an 8-lead MSOP package.







#### Rev. A

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#### **REVISION HISTORY**

| 10/07—Rev. 0 to Rev. A                       |           |
|--|-----------|
| Added MSOP Package                           | Universal |
| Changes to Features                          |           |
| Changes to General Description               | 1         |
| Changes to Table 1                           | 3         |
| Deleted Evaluation Board Information Section | 14        |
| Updated Outline Dimensions                   |           |
| Changes to Ordering Guide                    |           |
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#### 1/07—Revision 0: Initial Version

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### **SPECIFICATIONS**

 $V_{\rm DD}$  = 5.0 V,  $T_{\rm A}$  = 25°C,  $R_{\rm L}$  = 8  $\Omega$  + 33  $\mu H$  , unless otherwise noted.

#### Table 1.

| Parameter                          | Symbol              | Conditions   | Min | Тур  | Max                   | Unit |
|------------------------------------|---------------------|--|-----|------|-----------------------|------|
| DEVICE CHARACTERISTICS             |                     |  |     |      |                       |      |
| Output Power                       | Po                  | $V_{DD} = 5.0 \text{ V}, \text{R}_L = 8 \Omega, \text{THD} = 1\%$<br>f = 1 kHz, 20 kHz BW                    |     | 1.22 |                       | W    |
|                                    |                     | $V_{DD} = 5.0 \text{ V}, \text{R}_L = 8 \Omega, \text{THD} = 10\%$<br>f = 1 kHz, 20 kHz BW                   |     | 1.52 |                       | W    |
|                                    |                     | $V_{DD} = 3.6 \text{ V}, \text{ R}_L = 8 \Omega, \text{ THD} = 1\%$<br>f = 1 kHz, 20 kHz BW                  |     | 590  |                       | mW   |
|                                    |                     | $V_{DD} = 3.6 \text{ V}, \text{ R}_L = 8 \Omega, \text{ THD} = 10\%$   |     | 775  |                       | mW   |
|                                    |                     | f = 1 kHz, 20 kHz BW   |     |      |                       |      |
|                                    |                     | $V_{DD} = 2.5 \text{ V}, \text{R}_L = 8 \Omega, \text{THD} = 1\%$<br>f = 1 kHz, 20 kHz BW                    |     | 275  |                       | mW   |
|                                    |                     | $V_{DD} = 2.5 V, R_L = 8 \Omega, THD = 10\%$<br>f = 1 kHz, 20 kHz BW   |     | 345  |                       | mW   |
| Efficiency                         | η                   | $P_{\text{OUT}}=1.4~\text{W}, 8~\Omega, V_{\text{DD}}=5.0~\text{V}$  |     | 85   |                       | %    |
| Total Harmonic Distortion + Noise  | THD + N             | $P_0 = 1$ W into 8 $\Omega$ , f = 1 kHz, V <sub>DD</sub> = 5.0 V   |     | 0.1  |                       | %    |
|                                    |                     | $P_0 = 0.5$ W into 8 $\Omega$ , f = 1 kHz, $V_{DD} = 3.6$ V  |     | 0.04 |                       | %    |
| Input Common-Mode Voltage Range    | V <sub>CM</sub>     |  | 1.0 |      | V <sub>DD</sub> – 1.0 | V    |
| Common-Mode Rejection Ratio        |                     | $V_{CM} = 2.5 V \pm 100 \text{ mV}$ at 217 Hz  |     | 55   |                       | dB   |
| Average Switching Frequency        | fsw                 |  |     | 1.8  |                       | MHz  |
| Differential Output Offset Voltage | Voos                | G = 6 dB; G = 12 dB  |     | 2.0  |                       | mV   |
| POWER SUPPLY                       |                     |  |     |      |                       |      |
| Supply Voltage Range               | $V_{\text{DD}}$     | Guaranteed from PSRR test  | 2.5 |      | 5.0                   | V    |
| Power Supply Rejection Ratio       | PSRR                | $V_{DD} = 2.5 V$ to 5.0 V, dc input floating/ground  | 70  | 85   |                       | dB   |
|                                    | PSRR <sub>GSM</sub> | $V_{RIPPLE} = 100 \text{ mV}$ at 217 Hz, inputs are ac grounded,<br>$C_{IN} = 0.01 \mu$ F, input referred    |     | 63   |                       | dB   |
| Supply Current                     | Isy                 | $V_{IN} = 0 V$ , no load, $V_{DD} = 5.0 V$   |     | 4.2  |                       | mA   |
|                                    |                     | $V_{IN} = 0$ V, no load, $V_{DD} = 3.6$ V  |     | 3.5  |                       | mA   |
|                                    |                     | $V_{IN} = 0 V$ , no load, $V_{DD} = 2.5 V$   |     | 2.9  |                       | mA   |
| Shutdown Current                   | I <sub>SD</sub>     | $\overline{SD} = GND$  |     | 20   |                       | nA   |
| GAIN CONTROL                       |                     |  |     |      |                       |      |
| Closed-Loop Gain                   | A <sub>V</sub> 0    | GAIN pin = $0 V$   |     | 6    |                       | dB   |
|                                    | A <sub>V</sub> 1    | GAIN pin = $V_{DD}$  |     | 12   |                       | dB   |
| Differential Input Impedance       | Z <sub>IN</sub>     | $\overline{SD} = V_{DD}, \overline{SD} = GND$  |     | 150  |                       | kΩ   |
|                                    |                     |  |     | 210  |                       | kΩ   |
| SHUTDOWN CONTROL                   |                     |  |     |      |                       |      |
| Input Voltage High                 | VIH                 | I <sub>SY</sub> ≥ 1 mA   |     | 1.2  |                       | V    |
| Input Voltage Low                  | VIL                 | I <sub>SY</sub> ≤ 300 nA   |     | 0.5  |                       | V    |
| Turn-On Time                       | twu                 | $\overline{SD}$ rising edge from GND to V <sub>DD</sub>  |     | 30   |                       | ms   |
| Turn-Off Time                      | t <sub>sD</sub>     | $\overline{SD}$ falling edge from $V_{DD}$ to GND  |     | 5    |                       | μs   |
| Output Impedance                   | Zout                | $\overline{SD} = GND$  |     | >100 |                       | kΩ   |
| NOISE PERFORMANCE                  |                     |  |     |      |                       |      |
| Output Voltage Noise               | en                  | $V_{DD} = 2.5$ V to 5.0 V, f = 20 Hz to 20 kHz, inputs are ac grounded, sine wave, $A_V = 6$ dB, A weighting |     | 35   |                       | μV   |
| Signal-to-Noise Ratio              | SNR                 | $P_{OUT} = 1.4 \text{ W}, \text{ R}_{L} = 8 \Omega$  |     | 98   |                       | dB   |

### **ABSOLUTE MAXIMUM RATINGS**

Absolute maximum ratings apply at 25°C, unless otherwise noted.

#### Table 2.

| Parameter                            | Rating          |
|--------------------------------------|-----------------|
| Supply Voltage                       | 6 V             |
| Input Voltage                        | V <sub>DD</sub> |
| Common-Mode Input Voltage            | V <sub>DD</sub> |
| Storage Temperature Range            | –65°C to +150°C |
| Operating Temperature Range          | -40°C to +85°C  |
| Junction Temperature Range           | –65°C to +165°C |
| Lead Temperature (Soldering, 60 sec) | 300°C           |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### THERMAL RESISTANCE

 $\theta_{JA}$  is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

#### Table 3. Thermal Resistance

| Package Type                    | θ」Α | ονθ  | Unit |
|---------------------------------|-----|------|------|
| 8-lead, 3 mm $	imes$ 3 mm LFCSP | 62  | 20.8 | °C/W |
| 8-lead MSOP                     | 210 | 45   | °C/W |

#### ESD CAUTION



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## **PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS**

| SD 1   GAIN 2   IN+ 3   IN- 4 |     | PIN 1<br>INDICATOR<br>SSM2301<br>TOP VIEW<br>(Not to Scale) | 8765  | OUT–<br>GND<br>VDD<br>OUT+ | 06163-002 |
|-------------------------------|-----|---|-------|----------------------------|-----------|
| Figur                         | e 2 | 2. LFCSP Pin Coi  | nfigi | uration                    | -         |

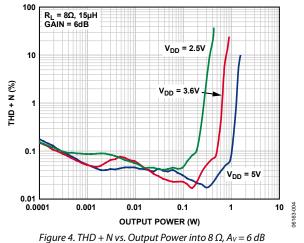


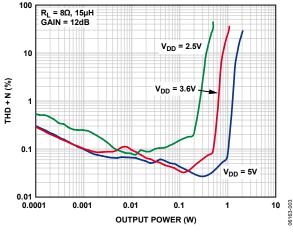
Figure 3. MSOP Pin Configuration

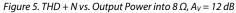
#### **Table 4. Pin Function Descriptions**

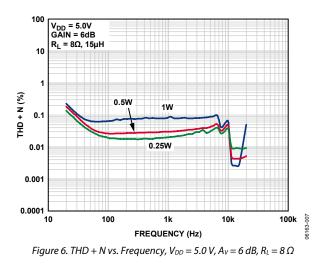
| Pin No. | Mnemonic | Description                               |
|---------|----------|---|
| 1       | SD       | Shutdown Input. Active low digital input. |
| 2       | GAIN     | Gain Selection. Digital input.            |
| 3       | IN+      | Noninverting Input.                       |
| 4       | IN-      | Inverting Input.                          |
| 5       | OUT+     | Noninverting Output.                      |
| 6       | VDD      | Power Supply.                             |
| 7       | GND      | Ground.                                   |
| 8       | OUT-     | Inverting Output.                         |

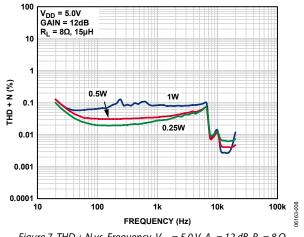
### **TYPICAL PERFORMANCE CHARACTERISTICS**

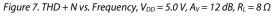


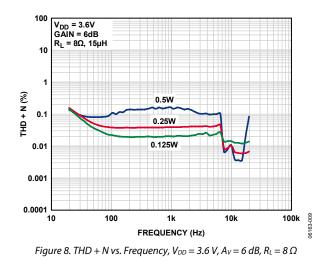


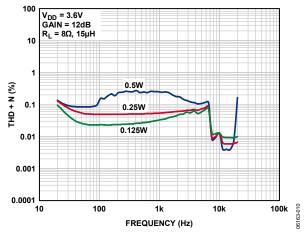


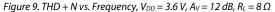


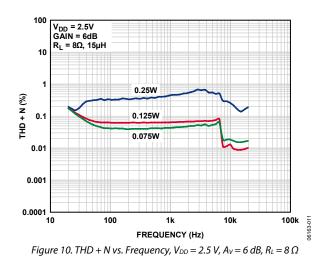


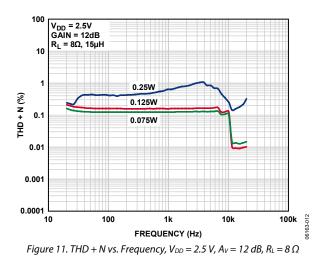












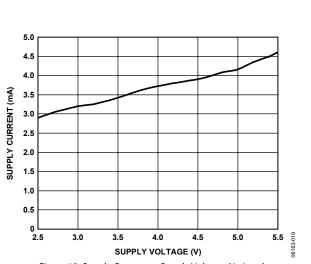
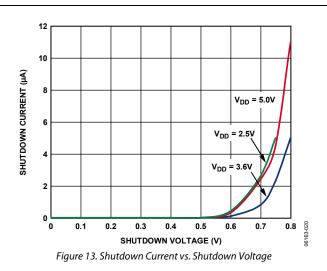


Figure 12. Supply Current vs. Supply Voltage, No Load



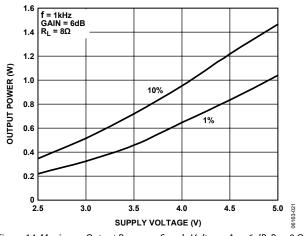


Figure 14. Maximum Output Power vs. Supply Voltage,  $A_V = 6 \, dB$ ,  $R_L = 8 \, \Omega$ ,

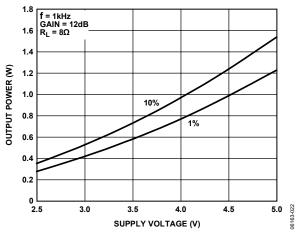
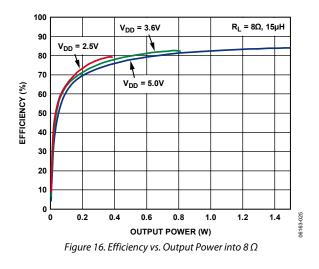
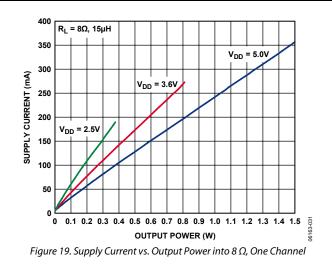
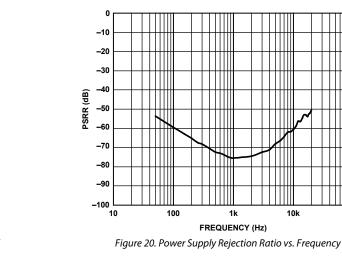
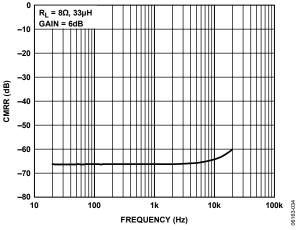


Figure 15. Maximum Output Power vs. Supply Voltage,  $A_V = 12 \, dB$ ,  $R_L = 8 \, \Omega$ 









100k

06163-033



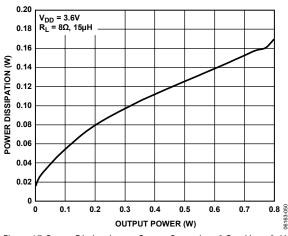
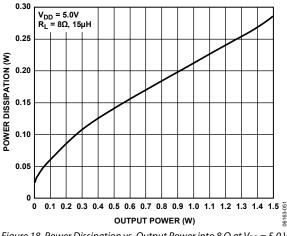
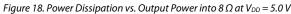
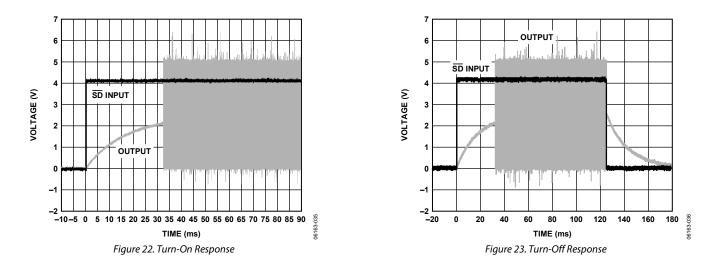


Figure 17. Power Dissipation vs. Output Power into 8  $\Omega$  at V<sub>DD</sub> = 3.6 V







### **TYPICAL APPLICATION CIRCUITS**

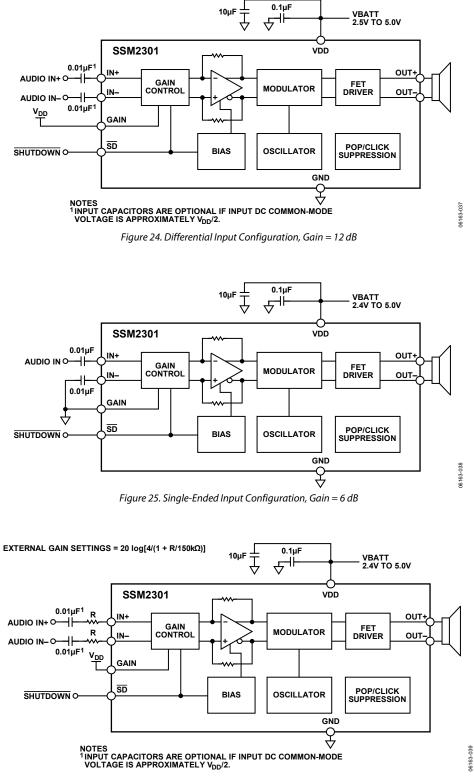
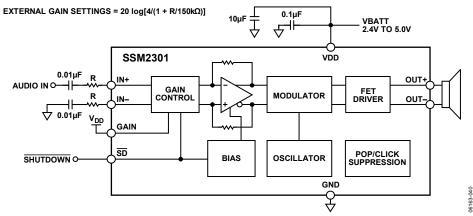
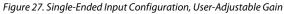
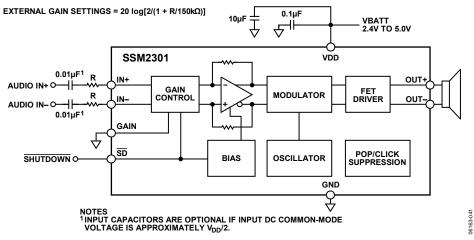


Figure 26. Differential Input Configuration, User-Adjustable Gain









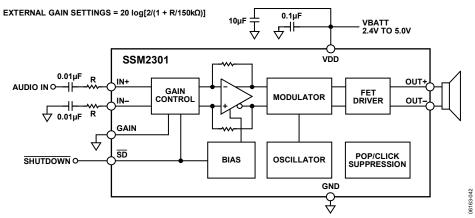


Figure 29. Single-Ended Input Configuration, User-Adjustable Gain

#### APPLICATIONS INFORMATION overview

The SSM2301 mono Class-D audio amplifier features a filterless modulation scheme that greatly reduces external component count, conserving board space and, thus, reducing system cost. The SSM2301 does not require an output filter but, instead, relies on the inherent inductance of the speaker coil and the natural filtering of the speaker and human ear to fully recover the audio component of the square-wave output. While most Class-D amplifiers use some variation of pulse-width modulation (PWM), the SSM2301 uses a  $\Sigma$ - $\Delta$  modulation to determine the switching pattern of the output devices. This provides a number of important benefits.  $\Sigma$ - $\Delta$  modulators do not produce a sharp peak with many harmonics in the AM frequency band, as pulse-width modulators often do.  $\Sigma$ - $\Delta$  modulation reduces the amplitude of spectral components at high frequencies, thereby reducing EMI emission that might otherwise be radiated by speakers and long cable traces. The SSM2301 also offers protection circuitry for output shortcircuit and high temperature conditions. When the fault-inducing condition is removed, the SSM2301 automatically recovers without the need for a hard reset.

#### GAIN SELECTION

Pulling the GAIN pin of the SSM2301 high sets the gain of the speaker amplifier to 12 dB; pulling it low sets the gain of the speaker amplifier to 6 dB.

It is possible to adjust the SSM2301 gain by using external resistors at the input. To set a gain lower than 12 dB, see Figure 26 for differential input configuration and Figure 27 for single-ended configuration. For external gain configuration from a fixed 12 dB gain, use the following formula:

*External Gain Settings* =  $20 \log[4/(1 + R/150 \text{ k}\Omega)]$ 

To set a gain lower than 6 dB, see Figure 28 for differential input configuration and Figure 29 for single-ended configuration. For external gain configuration from a fixed 6 dB gain, use the following formula:

External Gain Settings =  $20 \log[2/(1 + R/150 k\Omega)]$ 

#### **POP-AND-CLICK SUPPRESSION**

Voltage transients at the output of audio amplifiers may occur when shutdown is activated or deactivated. Voltage transients as low as 10 mV can be heard as an audio pop in the speaker. Clicks and pops can also be classified as undesirable audible transients generated by the amplifier system and, therefore, as not coming from the system input signal. Such transients may be generated when the amplifier system changes its operating mode. For example, the following can be sources of audible transients: system power-up/power-down, mute/unmute, input source change, and sample rate change. The SSM2301 has a popand-click suppression architecture that reduces these output transients, resulting in noiseless activation and deactivation.

#### LAYOUT

As output power continues to increase, care must be taken to lay out PCB traces and wires properly between the amplifier, load, and power supply. A good practice is to use short, wide PCB tracks to decrease voltage drops and minimize inductance. Make track widths at least 200 mil for every inch of track length for lowest DCR, and use 1 oz or 2 oz of copper PCB traces to further reduce IR drops and inductance.

Poor layout increases voltage drops, consequently affecting efficiency. Use large traces for the power supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance. Proper grounding guidelines help improve audio performance, minimize crosstalk between channels, and prevent switching noise from coupling into the audio signal. To maintain high output swing and high peak output power, PCB traces that connect the output pins to the load and supply pins should be as wide as possible to maintain the minimum trace resistances.

It is also recommended that a large-area ground plane be used for minimum impedances. Good PCB layouts also isolate critical analog paths from sources of high interference. High frequency circuits (analog and digital) should be separated from low frequency circuits. Properly designed multilayer printed circuit boards can reduce EMI emission and increase immunity to the RF field by a factor of 10 or more compared with double-sided boards. A multilayer board allows a complete layer to be used for the ground plane, whereas the ground plane side of a doubleside board is often disrupted with signal crossover. If the system has separate analog and digital ground and power planes, the analog ground plane should be underneath the analog power plane, and, similarly, the digital ground plane should be underneath the digital power plane. There should be no overlap between analog and digital ground planes or analog and digital power planes.

#### INPUT CAPACITOR SELECTION

The SSM2301 does not require input coupling capacitors if the input signal is biased from 1.0 V to  $V_{DD}$  – 1.0 V. Input capacitors are required if the input signal is not biased within this recommended input dc common-mode voltage range, if high-pass filtering is needed (see Figure 24) or if using a single-ended source (see Figure 25). If high-pass filtering is needed at the input, the input capacitor, along with the input resistor of the SSM2301, forms a high-pass filter whose corner frequency is determined by the following equation:

 $f_C = 1/(2\pi \times R_{IN} \times C_{IN})$ 

The input capacitor can have very important effects on the circuit performance. Not using input capacitors degrades the output offset of the amplifier as well as the PSRR performance.

#### **PROPER POWER SUPPLY DECOUPLING**

To ensure high efficiency, low total harmonic distortion (THD), and high PSRR, proper power supply decoupling is necessary. Noise transients on the power supply lines are short-duration voltage spikes. Although the actual switching frequency can range from 10 kHz to 100 kHz, these spikes can contain frequency components that extend into the hundreds of megahertz. The power supply input needs to be decoupled with a good quality low ESL and low ESR capacitor, usually around 4.7  $\mu$ F. This capacitor bypasses low frequency noises to the ground plane. For high frequency transients noises, use a 0.1  $\mu$ F capacitor placed as close as possible to the VDD pin of the device. Placing the decoupling capacitor as close as possible to the SSM2301 helps maintain efficient performance.

### **OUTLINE DIMENSIONS**

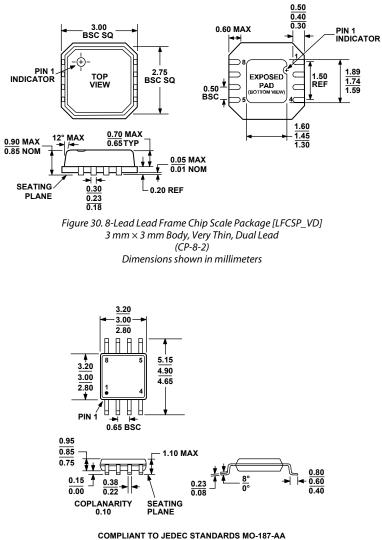


Figure 31. 8-Lead Mini Small Outline Package [MSOP] (RM-8) Dimensions shown in millimeters

#### **ORDERING GUIDE**

|                              | Temperature    |   | Package |          |
|------------------------------|----------------|---|---------|----------|
| Model                        | Range          | Package Description                             | Option  | Branding |
| SSM2301CPZ-R2 <sup>1</sup>   | -40°C to +85°C | 8-Lead Lead Frame Chip Scale Package [LFCSP_VD] | CP-8-2  | A1C      |
| SSM2301CPZ-REEL <sup>1</sup> | -40°C to +85°C | 8-Lead Lead Frame Chip Scale Package [LFCSP_VD] | CP-8-2  | A1C      |
| SSM2301CPZ-REEL71            | -40°C to +85°C | 8-Lead Lead Frame Chip Scale Package [LFCSP_VD] | CP-8-2  | A1C      |
| SSM2301RMZ-R2 <sup>1</sup>   | -40°C to +85°C | 8-Lead Mini Small Outline Package [MSOP]        | RM-8    | A1C      |
| SSM2301RMZ-REEL <sup>1</sup> | -40°C to +85°C | 8-Lead Mini Small Outline Package [MSOP]        | RM-8    | A1C      |
| SSM2301RMZ-REEL71            | -40°C to +85°C | 8-Lead Mini Small Outline Package [MSOP]        | RM-8    | A1C      |
| SSM2301-EVALZ <sup>1</sup>   |                | Evaluation Board with LFCSP Model               |         |          |

<sup>1</sup> Z = RoHS Compliant Part.

### NOTES

## NOTES

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